

ABSTRACT OF THE DISCLOSURE

A method of fabricating a chip type power inductor includes the steps of: ~~A fabrication method of a chip type power inductor comprising:~~ preparing green sheets; ~~that a magnetic layer and a non-magnetic layer are respectively formed on a carrier film;~~ forming cutting lines on ~~[[the]]~~ a magnetic layer green sheet and ~~[[the]]~~ a non-magnetic layer green sheet; forming via holes on the non-magnetic layer green sheet where the cutting lines are formed, and forming an electrode pattern at an upper surface of the non-magnetic layer green sheet; ~~picking up unnecessary parts from the magnetic layer green sheet and the non-magnetic layer green sheet and thus corresponding remaining parts of the magnetic substance to the picked up parts of the non-magnetic substance or corresponding the picked up parts of the magnetic substance to remaining parts of the non-magnetic substance;~~ stacking a plurality of layers by constituting the magnetic layer and the non-magnetic layer where via holes and electrode patterns are formed as one unit in a state that a non-magnetic layer where cutting lines and electrode patterns are not formed is inserted; stacking a cover layer composed of a magnetic layer at upper and lower surfaces of the stacked layers; firing the stacked body; and forming external electrodes at an outer surface of the fired stack body.